



20V N-Channel Trench Power MOSFET

General Description

The SJS2300 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a wide variety of applications.

Features

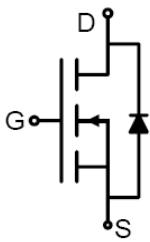
- Low Gate Charge
- High Power and current handing capability
- Lead free product is acquired

Application

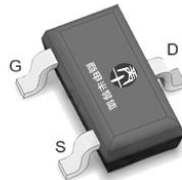
- PWM Applications
- Load Switch
- Power Management

Key Performance Parametes

Parameter	Value	Unit
V_{DS}	20	V
$R_{DS(ON_TYP)}$	14.7	mΩ
I_D	6	A
Q_G	9	nC



Schematic Diagram



SOT-23 view



Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJS2300	2300	SOT-23	Tape	\	\	3000 Pcs

Table 1. Absolute Maximum Ratings ($T_A=25^{\circ}\text{C}$ unless otherwise noted)

Symbol	Parameter	Limit	Unit
V_{DS}	Drain-Source Voltage ($V_{GS}=0\text{V}$)	20	V
V_{GS}	Gate-Source Voltage ($V_{DS}=0\text{V}$)	± 10	V
I_D	Drain Current-Continuous($T_A=25^{\circ}\text{C}$)	6	A
	Drain Current-Continuous($T_A=100^{\circ}\text{C}$)	3.8	A
$I_{DM}(\text{pluse})$	Drain Current-Continuous@ Current-Pulsed (Note 1)	24	A
P_D	Maximum Power Dissipation($T_A=25^{\circ}\text{C}$)	0.96	W
	Maximum Power Dissipation($T_A=100^{\circ}\text{C}$)	0.4	W
E_{AS}	Avalanche energy (Note 2)	16	mJ
T_J, T_{STG}	Operating Junction and Storage Temperature Range	-55 To 150	$^{\circ}\text{C}$

Table 2. Thermal Characteristic

Symbol	Parameter	Typ	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to- Ambient		130	$^{\circ}\text{C/W}$



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Table 3. Electrical Characteristics ($T_J=25^{\circ}\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V I _D =250μA	20			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =20V, V _{GS} =0V T _J =25℃			1	μA
		V _{DS} =20V, V _{GS} =0V T _J =125℃			100	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±12V, V _{DS} =0V			±100	uA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	0.45		1	V
g _{FS}	Forward Transconductance	V _{DS} =4.5V, I _D =1.5A		5.8		S
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =4.5V, I _D =1.5A T _J =25℃		14.7	18.4	mΩ
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =2.5V, I _D =1A T _J =25℃		19.1	25.4	mΩ
Dynamic Characteristics						
C _{iss}	Input Capacitance	V _{DS} =10V,V _{GS} =0V, f=1.0KHz		564		pF
C _{oss}	Output Capacitance			69		pF
C _{rss}	Reverse Transfer Capacitance			60		pF
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1.0MHz		8.5		Ω
Switching Parameters						
t _{d(on)}	Turn-on Delay Time	V _{GS} =4.5V, V _{DS} =10V, R _L =6.7Ω, R _{GEN} =3Ω		3		nS
t _r	Turn-on Rise Time			11		nS
t _{d(off)}	Turn-Off Delay Time			20		nS
t _f	Turn-Off Fall Time			8		nS
Q _g	Total Gate Charge	V _{GS} =4.5V, V _{DS} =10V, I _D =1.5A		9		nC
Q _{gs}	Gate-Source Charge			1.5		nC
Q _{gd}	Gate-Drain Charge			2		nC
Source-Drain Diode Characteristics						
I _{SD}	Source-Drain Current (Body Diode)				6	A
V _{SD}	Forward on Voltage (Note 3)	V _{GS} =0V, I _S =1.5A			1.2	V
t _{rr}	Reverse Recovery Time	I _F =1.5A, dI/dt=100A/μs		4.3		ns
Q _{rr}	Reverse Recovery Charge	I _F =1.5A, dI/dt=100A/μs		0.6		nC

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

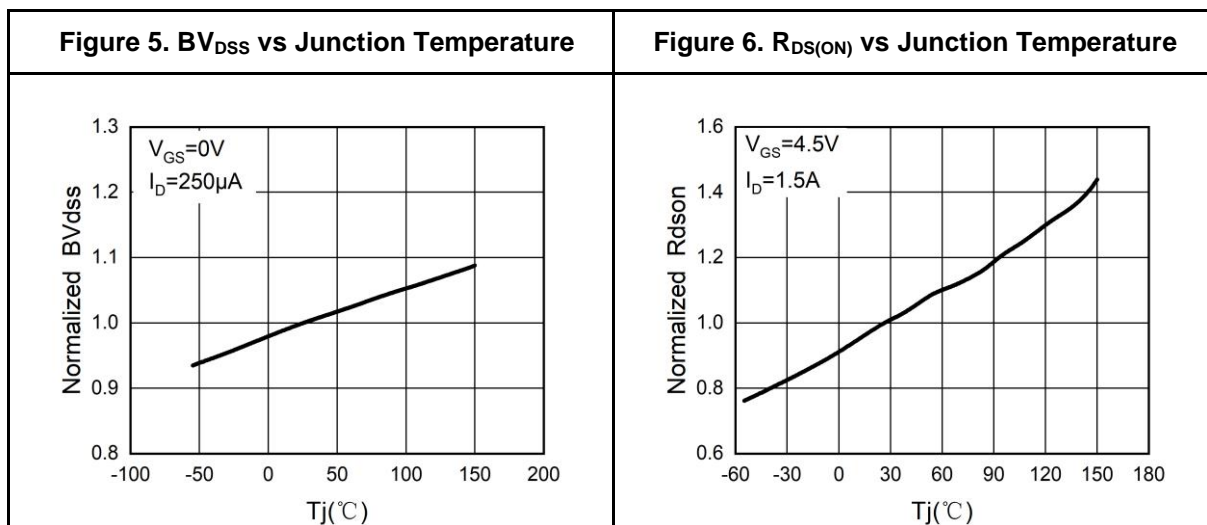
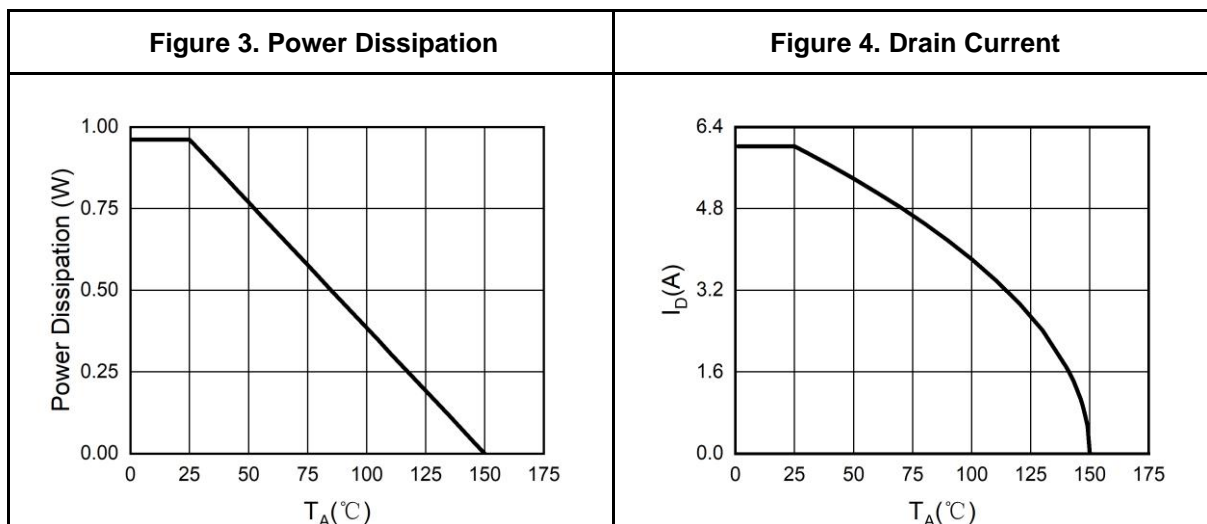
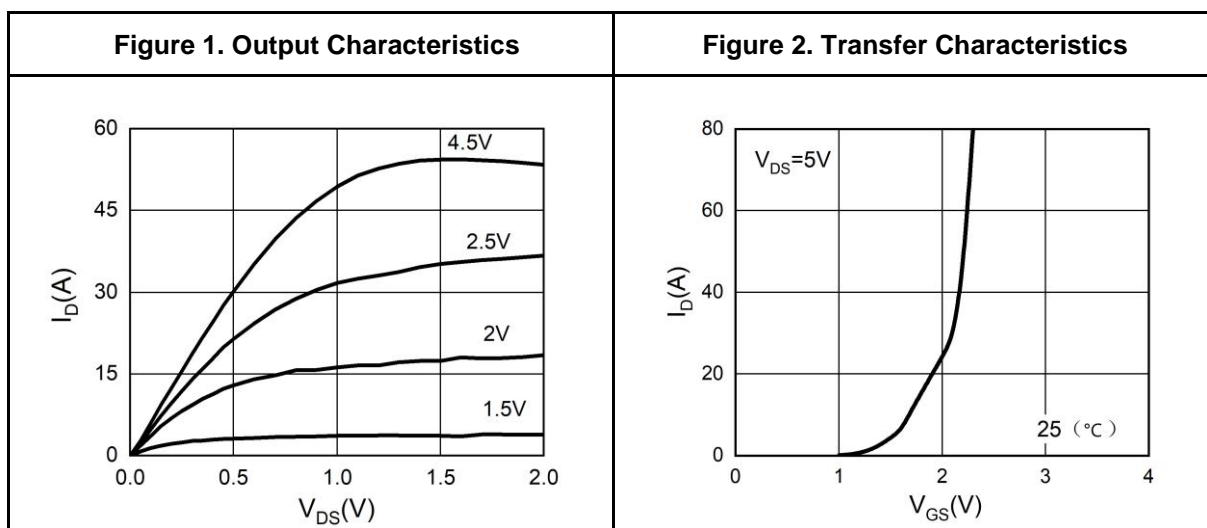
Notes 2.EAS condition: $T_J=25^{\circ}\text{C}, V_{DD}=10V, V_G=10V, R_g=25\Omega, L=0.5mH$.

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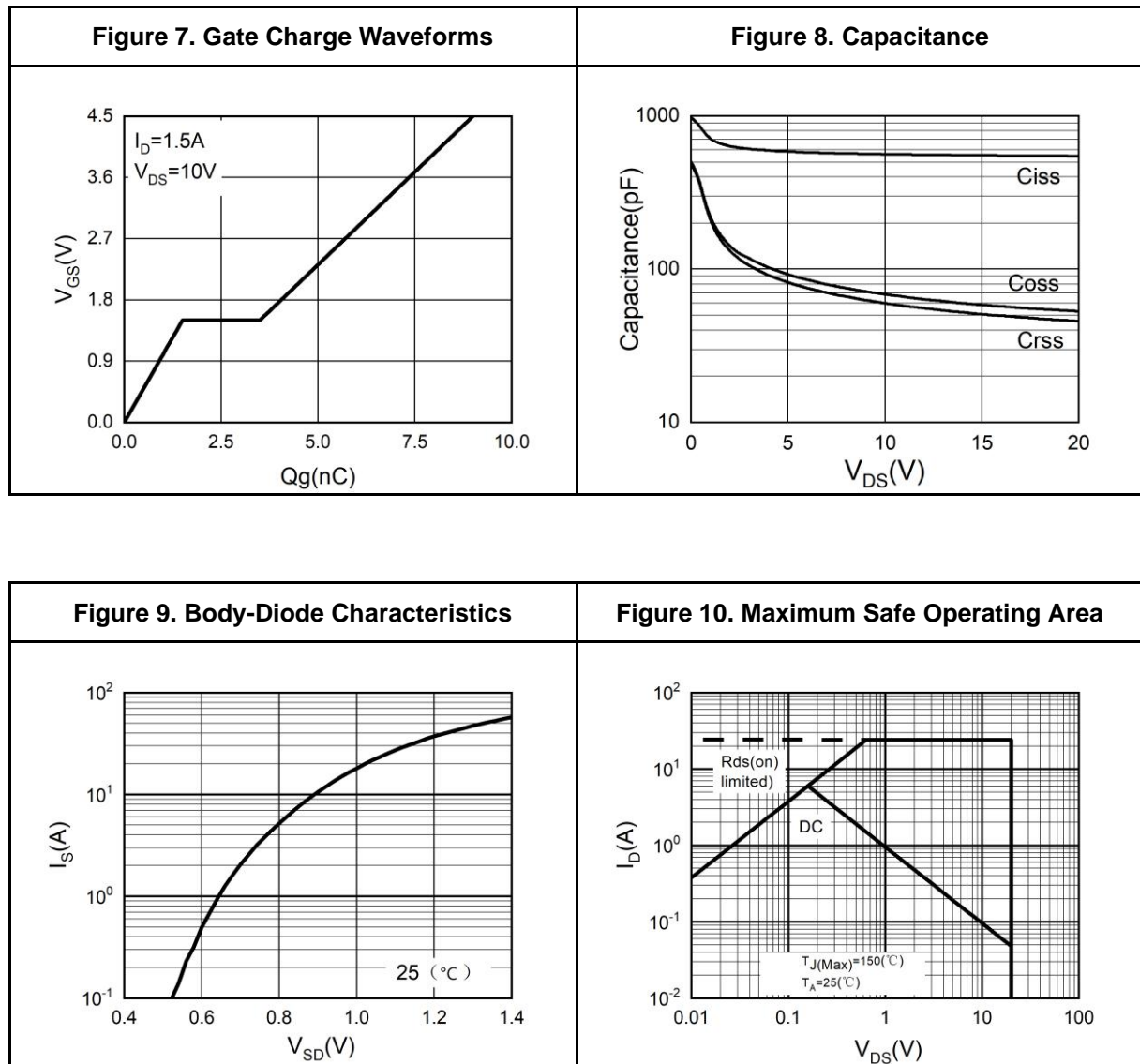
Typical Electrical And Thermal Characteristics (Curves)





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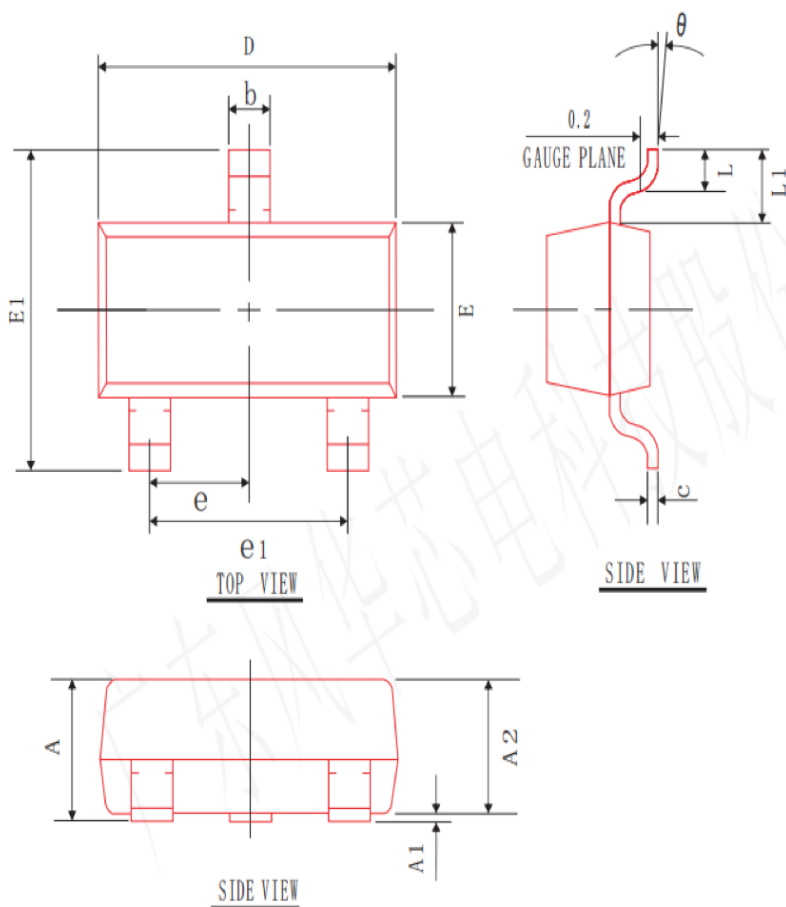
Typical Electrical And Thermal Characteristics (Curves)





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SOT-23 Package Information



COMMON DIMENSIONS
(UNITS OF MEASURE=mm)

SYMBOL	MIN	NOM	MAX
A	0.90	1.05	1.20
A1	0.00	0.05	0.10
A2	0.90	1.00	1.10
b	0.30	0.40	0.50
c	0.08	0.10	0.15
D	2.80	2.90	3.00
E	1.20	1.30	1.40
E1	2.30	2.40	2.50
L	0.30	0.40	0.50
θ	0°	5°	10°
L1	0.55 REF		
e	0.95 BSC		
e1	1.90 REF		

SYMBOL	MIN	NOM	MAX
A	0.90	1.05	1.20
A1	0.00	0.05	0.10
A2	0.90	1.00	1.10
b	0.30	0.40	0.50
c	0.08	0.10	0.15
D	2.80	2.90	3.00
E	1.20	1.30	1.40
E1	2.30	2.40	2.50
L	0.30	0.40	0.50
θ	0°	5°	10°
L1	0.55 REF		
e	0.95 BSC		
e1	1.90 REF		



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Attention

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